ASSOCIATION CONNEC	Material Composit © Copyright 2005. IPC, 1 international and Pan-An	Bannockb	urn, Illinois. A	ll rights reserved u ntions.	nder both	This docum level parts,	ent is a declara the declaration	tion of the s encompass	ubstances es all lower	within the manufactur r level materials for w	rer listed	item. Note: i nanufacture	f the item is an as r has engineering	ssembly with lower responsibility.	
1752-21.1	IPC Web Site for Information on IPC-1752 Standard Form Ty _I http://www.ipc.org/IPC-175x Distribute				e *	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materi					als and Mfg Information				
Supplier Info	rmation														
Company name*			Company unique ID			Unique ID Authority					Response Date*				
onsemi											2023-06-08				
Contact Name			Title - Contact				Phone - Contact*				Email -	Email - Contact*			
Product-Env-Stewards			Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
Authorized Representative*			Title - Representative				Phone - Representative*			Email - Representative*					
Product-Env-Ste	ewards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
Reque	ester Item Number	m Number Mfr Item Number		Mfr Item Name			Effective Dat	e Version	N	Manufacturing Site		Weight*	UOM	Unit Type	
		LC72725KV-TLM-E RDS		RDS/RBDS demodulation-IC		2023-06-08		F	РНМ		80.0	mg	Each		
Manufacturin	g Proccess Information	l									1				
Termin	Terminal Plating / Grid Array Material Ter		erminal Base Alloy J-STD-020 MS		L Rating	Peak Process Body Temperatu		e Max Time at Peak	Tempera	ture Numb	per of Reflow Cy	cles			
contains Bi CU			J Alloy 3				260 C 30			30	seconds 3				
Comments															
ATTENTION: M	ISL 3 Rated item requires Ba	ke and D	ry Pack (after	electrical test)											
for more inform	ation regarding material com	position p	olease refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Disobutyl phthalate (DIBP).										
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe v others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and co for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all						
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	2.32	mg	Supplier	Silicon (Si)	7440-21-3		2.3114	mg
			Supplier	Polyimide	Proprietary Data		0.0086	mg
Die Attach	0.49	mg	Supplier	Silver (Ag)	7440-22-4		0.3334	mg
			Supplier	Epoxy resins	129915-35-1		0.1417	mg
			Supplier	Other Metal Oxide	Proprietary Data		0.0107	mg
			В	Antimony Pentoxide (Sb2O5)	1314-60-9		0.0042	mg
Lead Frame	7.05	mg	Supplier	Silver (Ag)	7440-22-4		0.487	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0082	mg
			Supplier	Iron (Fe)	7439-89-6		0.1542	mg
			Supplier	Copper (Cu)	7440-50-8		6.3951	mg
			Supplier	Phosphorus (P)	7723-14-0		0.0054	mg
Mold Compound-Black	68.63	mg		Brominated epoxy resin	proprietary data		0.6863	mg
			Supplier	Epoxy Phenol Resin	Proprietary Data		0.549	mg
			В	Antimony Trioxide (Sb2O3)	1309-64-4		0.6863	mg
			Supplier	Carbon Black (C)	1333-86-4		0.6863	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		57.6492	mg
			Supplier	Ortho-Cresol Novolac Resin	29690-82-2		8.2356	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		0.1373	mg
Plating	1.13	mg	Supplier	Tin (Sn)	7440-31-5		1.13	mg
Wire Bond - Au	0.38	mg	Supplier	Gold (Au)	7440-57-5		0.38	mg